# Analog Multiplexers / Demultiplexers with LSTTL Compatible Inputs 

## High-Performance Silicon-Gate CMOS

## MC74HCT4051A, MC74HCT4052A, MC74HCT4053A

The MC74HCT4051A, MC74HCT4052A and MC74HCT4053A utilize silicon-gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF leakage currents. These analog multiplexers/demultiplexers control analog voltages that may vary across the complete power supply range (from $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$ ).

The HCT4051A, HCT4052A and HCT4053A are identical in pinout to the metal-gate MC14051AB, MC14052AB and MC14053AB. The Channel-Select inputs determine which one of the Analog Inputs/Outputs is to be connected, by means of an analog switch, to the Common Output/Input. When the Enable pin is HIGH, all analog switches are turned off.

The Channel-Select and Enable inputs are compatible with standard CMOS and LSTTL outputs.

These devices have been designed so that the ON resistance $\left(\mathrm{R}_{\text {on }}\right)$ is more linear over input voltage than $\mathrm{R}_{\mathrm{on}}$ of metal-gate CMOS analog switches.

For a multiplexer/demultiplexer with injection current protection, see HC4851A and HCT4851A.

## Features

- Fast Switching and Propagation Speeds
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Analog Power Supply Range $\left(\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}\right)=2.0$ to 12.0 V
- Digital (Control) Power Supply Range $\left(\mathrm{V}_{\mathrm{CC}}-\mathrm{GND}\right)=2.0$ to 6.0 V
- Improved Linearity and Lower ON Resistance Than Metal-Gate

Counterparts

- Low Noise
- In Compliance with the Requirements of JEDEC Standard No. 7 A
- Chip Complexity: HCT4051A - 184 FETs or 46 Equivalent Gates HCT4052A - 168 FETs or 42 Equivalent Gates HCT4053A - 156 FETs or 39 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring

Unique Site and Control Change Requirements; AEC-Q100
Qualified and PPAP Capable

- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant



## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 13 of this data sheet.
NOTE: Some of the devices on this data sheet have been DISCONTINUED. Please refer to the table on page 13.


Figure 1. Logic Diagram - MC74HCT4051A Single-Pole, 8-Position Plus Common Off

FUNCTION TABLE - MC74HCT4051A

| Control Inputs |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Select |  |  |  |
| Enable | C | B | A | ON Channels |
| L | L | L | L | X0 |
| L | L | L | H | X1 |
| L | L | H | L | X2 |
| L | L | H | H | X3 |
| L | H | L | L | X4 |
| L | H | L | H | X5 |
| L | H | H | L | X6 |
| L | H | H | H | X7 |
| H | X | X | X | NONE |
| X = Don't Care |  |  |  |  |



Figure 2. Pinout: MC74HCT4051A
(Top View)

FUNCTION TABLE - MC74HCT4052A



Figure 4. Pinout: MC74HCT4052A (Top View)


NOTE: This device allows independent control of each switch. Channel-Select Input A controls the X-Switch, Input B controls the $\mathrm{Y}-$ Switch and Input C controls the $\mathrm{Z}-$ Switch

Figure 5. Logic Diagram - MC74HCT4053A Triple Single-Pole, Double-Position Plus Common Off

FUNCTION TABLE - MC74HCT4053A

| Control Inputs |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Select |  |  |  |  |
| Enable | C | B | A | ON Channels |  |  |
| L | L | L | L | Z0 | Yo | X0 |
| L | L | L | H | Z0 | Yo | X1 |
| L | L | H | L | Z0 | Y1 | X0 |
| L | L | H | H | Z0 | Y1 | X1 |
| L | H | L | L | Z1 | Y0 | X0 |
| L | H | L | H | Z1 | Y0 | X1 |
| L | H | H | L | Z1 | Y1 | X0 |
| L | H | H | H | Z1 | Y1 | X1 |
| H | X | X | X |  | NONE |  |

X $=$ Don't Care


Figure 6. Pinout: MC74HCT4053A (Top View)

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage(Referenced to GND) <br> (Referenced to $\mathrm{V}_{\mathrm{EE}}$ ) | -0.5 to +7.0 <br> -0.5 to +14.0 | V |
| $\mathrm{~V}_{\mathrm{EE}}$ | Negative DC Supply Voltage (Referenced to GND) | -7.0 to +5.0 | V |
| $\mathrm{~V}_{\text {IS }}$ | Analog Input Voltage | $\mathrm{V}_{\mathrm{EE}}-0.5$ to <br> $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{~V}_{\text {in }}$ | Digital Input Voltage (Referenced to GND) | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| I | DC Current, Into or Out of Any Pin | $\pm 25$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air,SOIC Packaget <br> TSSOP Packaget | 500 <br> 450 | mW |
| $\mathrm{~T}_{\mathrm{stg}}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {in }}$ and $V_{\text {out }}$ should be constrained to the range $\mathrm{GND} \leq\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{CC}}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or $\mathrm{V}_{\mathrm{CC}}$ ). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
$\dagger$ Derating - SOIC Package: - $7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
TSSOP Package: $-6.1 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$

# MC74HCT4051A, MC74HCT4052A, MC74HCT4053A 

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage $\begin{array}{r}\text { (Referenced to GND) } \\ \text { (Referenced to } \mathrm{V}_{\text {EE }} \text { ) }\end{array}$ | $\begin{aligned} & \hline 2.0 \\ & 2.0 \end{aligned}$ | $\begin{gathered} 6.0 \\ 12.0 \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{EE}}$ | Negative DC Supply Voltage, Output (Referenced to GND) | -6.0 | GND | V |
| $\mathrm{V}_{\text {IS }}$ | Analog Input Voltage | $\mathrm{V}_{\mathrm{EE}}$ | $\mathrm{V}_{\text {CC }}$ | V |
| $V_{\text {in }}$ | Digital Input Voltage (Referenced to GND) | GND | $\mathrm{V}_{\text {CC }}$ | V |
| $V_{10}{ }^{*}$ | Static or Dynamic Voltage Across Switch |  | 1.2 | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range, All Package Types | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Input Rise/Fall Time $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ <br> (Channel Select or Enable Inputs) $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | $\begin{aligned} & 0 \\ & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & \hline 1000 \\ & 600 \\ & 500 \\ & 400 \end{aligned}$ | ns |

*For voltage drops across switch greater than 1.2 V (switch on), excessive $\mathrm{V}_{\mathrm{CC}}$ current may be drawn; i.e., the current out of the switch may contain both $\mathrm{V}_{\mathrm{CC}}$ and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS - Digital Section (Voltages Referenced to GND) $\mathrm{V}_{\mathrm{EE}}=$ GND, Except Where Noted

| Symbol | Parameter | Condition | $\begin{gathered} \mathrm{v}_{\mathrm{cc}} \\ \mathrm{~V} \end{gathered}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ | $\leq 85{ }^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum High-Level Input Voltage, Channel-Select or Enable Inputs | $\mathrm{R}_{\text {on }}=$ Per Spec | $\begin{array}{\|c\|} \hline 4.5 \text { to } \\ 5.5 \end{array}$ | 2.0 | 2.0 | 2.0 | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs | $\mathrm{R}_{\text {on }}=$ Per Spec | $\begin{array}{\|c} 4.5 \text { to } \\ 5.5 \end{array}$ | 0.8 | 0.8 | 0.8 | V |
| $\mathrm{l}_{\text {in }}$ | Maximum Input Leakage Current, Channel-Select or Enable Inputs | $\begin{aligned} & V_{\text {in }}=V_{C C} \text { or GND, } \\ & V_{E E}=-6.0 \mathrm{~V} \end{aligned}$ | 6.0 | $\pm 0.1$ | $\pm 1.0$ | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | Maximum Quiescent Supply Current (per Package) | Channel Select, Enable and $\mathrm{V}_{\text {IS }}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\quad \mathrm{V}_{\mathrm{EE}}=\mathrm{GND}$ $\mathrm{V}_{\text {IO }}=0 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{EE}}=-6.0$ | $\begin{aligned} & 6.0 \\ & 6.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1 \\ & 4 \end{aligned}$ | $\begin{aligned} & 10 \\ & 40 \end{aligned}$ | $\begin{aligned} & 20 \\ & 80 \end{aligned}$ | $\mu \mathrm{A}$ |

## DC CHARACTERISTICS - Analog Section

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{Cc}}$ | $\mathrm{V}_{\mathrm{EE}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{R}_{\text {on }}$ | Maximum "ON" Resistance | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{HH}} ; \mathrm{V}_{\mathrm{IS}}=\mathrm{V}_{\mathrm{CC}} \text { to } \\ & \mathrm{V}_{\text {EEE }} ; \mathrm{II}_{\mathrm{S}} \leq 2.0 \mathrm{~mA} \\ & \text { (Figures } 7,8 \text { ) } \end{aligned}$ | $\begin{aligned} & \hline 4.5 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 0.0 \\ -4.5 \\ -6.0 \end{gathered}$ | $\begin{aligned} & \hline 190 \\ & 120 \\ & 100 \end{aligned}$ | $\begin{aligned} & 240 \\ & 150 \\ & 125 \end{aligned}$ | $\begin{aligned} & 280 \\ & 170 \\ & 140 \end{aligned}$ | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} ; \mathrm{V}_{\mathrm{IS}}=\mathrm{V}_{\mathrm{CC}} \text { or } \\ & \mathrm{V}_{\mathrm{EE}} \text { (Endpoints); } \mathrm{I}_{\mathrm{I}} \leq 2.0 \mathrm{~mA} \\ & \text { (Figures } 7,8 \text { ) } \end{aligned}$ | $\begin{aligned} & \hline 4.5 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{array}{\|c\|} \hline 0.0 \\ -4.5 \\ -6.0 \end{array}$ | $\begin{gathered} 150 \\ 100 \\ 80 \end{gathered}$ | $\begin{aligned} & 190 \\ & 125 \\ & 100 \end{aligned}$ | $\begin{aligned} & 230 \\ & 140 \\ & 115 \end{aligned}$ |  |
| $\Delta \mathrm{R}_{\text {on }}$ | Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\text {IH }} \\ & \mathrm{V}_{\text {IS }}=1 / 2\left(\mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EEE}}\right) ; \\ & \mathrm{I}_{\mathrm{S}} \leq 2.0 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & \hline 4.5 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 0.0 \\ -4.5 \\ -6.0 \end{gathered}$ | $\begin{aligned} & \hline 30 \\ & 12 \\ & 10 \end{aligned}$ | $\begin{aligned} & 35 \\ & 15 \\ & 12 \end{aligned}$ | $\begin{aligned} & 40 \\ & 18 \\ & 14 \end{aligned}$ | $\Omega$ |
| $\mathrm{l}_{\text {off }}$ | Maximum Off-Channel Leakage Current, Any One Channel | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{I L} \text { or } \mathrm{V}_{I H} ; \\ & \mathrm{V}_{I O}=\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{E E} ; \\ & \text { Switch Off (Figure 9) } \end{aligned}$ | 5.0 | -5.0 | 0.1 | 0.5 | 1.0 | $\mu \mathrm{A}$ |
|  | Maximum Off-Channel HCT4051A <br> Leakage Current, HCT4052A <br> Common Channel HCT4053A | $\begin{aligned} & V_{\text {in }}=V_{I L} \text { or } V_{I H} ; \\ & V_{I O}=V_{C C}-V_{E E} ; \\ & \text { Switch Off (Figure 10) } \end{aligned}$ | $\begin{aligned} & \hline 5.0 \\ & 5.0 \\ & 5.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline-5.0 \\ & -5.0 \\ & -5.0 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 0.1 \\ & 0.1 \\ & \hline \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 2.0 \\ & 2.0 \\ & \hline \end{aligned}$ |  |
| $\mathrm{I}_{\text {on }}$ | Maximum On-Channel HCT4051A Leakage Current, <br> HCT4052A <br> Channel-to-Channel <br> HCT4053A | $V_{\text {in }}=V_{\text {IL }} \text { or } V_{\text {IH }}$ <br> Switch-to-Switch = $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}$; (Figure 11) | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & \hline-5.0 \\ & -5.0 \\ & -5.0 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & \hline 2.0 \\ & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & \hline 4.0 \\ & 2.0 \\ & 2.0 \end{aligned}$ | $\mu \mathrm{A}$ |

AC CHARACTERISTICS ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}$ )

| Symbol | Parameter | $\mathrm{v}_{\mathrm{cc}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | -55 to $25^{\circ} \mathrm{C}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\begin{aligned} & \hline \mathrm{t}_{\text {PLH }}, \\ & \mathrm{t}_{\text {PHL }} \end{aligned}$ | Maximum Propagation Delay, Channel-Select to Analog Output (Figure 15) | $\begin{aligned} & \hline 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} 270 \\ 90 \\ 59 \\ 45 \end{gathered}$ | $\begin{aligned} & 320 \\ & 110 \\ & 79 \\ & 65 \end{aligned}$ | $\begin{gathered} 350 \\ 125 \\ 85 \\ 75 \end{gathered}$ | ns |
| $\begin{aligned} & \hline \mathrm{tpLH}^{2}, \\ & \mathrm{t}_{\text {PHL }} \end{aligned}$ | Maximum Propagation Delay, Analog Input to Analog Output (Figure 16) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 40 \\ & 25 \\ & 12 \\ & 10 \end{aligned}$ | $\begin{aligned} & \hline 60 \\ & 30 \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & \hline 70 \\ & 32 \\ & 18 \\ & 15 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLZ, } \\ & \text { tPHZ } \end{aligned}$ | Maximum Propagation Delay, Enable to Analog Output (Figure 17) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 160 \\ & 70 \\ & 48 \\ & 39 \end{aligned}$ | $\begin{gathered} 200 \\ 95 \\ 63 \\ 55 \end{gathered}$ | $\begin{aligned} & 220 \\ & 110 \\ & 76 \\ & 63 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpzL, } \\ & \text { tpzH } \end{aligned}$ | Maximum Propagation Delay, Enable to Analog Output (Figure 17) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 245 \\ & 115 \\ & 49 \\ & 39 \end{aligned}$ | $\begin{aligned} & 315 \\ & 145 \\ & 69 \\ & 58 \end{aligned}$ | $\begin{aligned} & 345 \\ & 155 \\ & 83 \\ & 67 \end{aligned}$ | ns |
| $\mathrm{C}_{\text {in }}$ | Maximum Input Capacitance, Channel-Select or Enable Inputs |  | 10 | 10 | 10 | pF |
| $\mathrm{C}_{1 / \mathrm{O}}$ | Maximum Capacitance Analog I/O <br> (All Switches Off) Common O/I: $\mathrm{HCT4051A}$ <br>  HCT4052A <br>  HCT4053A <br>  Feed-through |  | $\begin{gathered} \hline 35 \\ \hline 130 \\ 80 \\ 50 \\ \hline 1.0 \end{gathered}$ | $\begin{gathered} \hline 35 \\ \hline 130 \\ 80 \\ 50 \\ \hline 1.0 \end{gathered}$ | $\begin{gathered} \hline 35 \\ \hline 130 \\ 80 \\ 50 \\ \hline 1.0 \end{gathered}$ | pF |


| CPD | Power Dissipation Capacitance (Figure 19)* | HCT4051A HCT4052A HCT4053A | Typical @ 25 ${ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ | pF |
| :---: | :---: | :---: | :---: | :---: |
|  |  |  | 45 |  |
|  |  |  | 80 |  |
|  |  |  | 45 |  |

*Used to determine the no-load dynamic power consumption: $P_{D}=C_{P D} V_{C C}{ }^{2 f}+I_{C C} V_{C C}$.

ADDITIONAL APPLICATION CHARACTERISTICS (GND = 0 V)

| Symbol | Parameter | Condition | $\underset{\mathrm{V}}{\mathrm{v}_{\mathrm{cc}}}$ | $\mathrm{v}_{\mathrm{EE}}$ | Limit* |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | $25^{\circ} \mathrm{C}$ |  |  |  |
| BW | Maximum On-Channel Bandwidth or Minimum Frequency Response (Figure 12) | $f_{\text {in }}=1 \mathrm{MHz}$ Sine Wave; Adjust $f_{\text {in }}$ Voltage to Obtain 0 dBm at $\mathrm{V}_{\mathrm{OS}}$; Increase $\mathrm{f}_{\text {in }}$ Frequency Until dB Meter Reads -3 dB ;$\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ |  |  | '51 | '52 | '53 | MHz |
|  |  |  | 2.25 | -2.25 | 80 | 95 | 120 |  |
|  |  |  | 4.50 | -4.50 | 80 | 95 | 120 |  |
|  |  |  | 6.00 | -6.00 | 80 | 95 | 120 |  |
| - | Off-Channel Feed-through Isolation (Figure 13) | $\mathrm{f}_{\text {in }}=$ Sine Wave; Adjust $\mathrm{f}_{\text {in }}$ Voltage to | 2.25 | -2.25 |  | -50 |  | dB |
|  |  | Obtain 0 dBm at $\mathrm{V}_{\text {IS }}$ | 4.50 | -4.50 |  | -50 |  |  |
|  |  | $\mathrm{f}_{\mathrm{in}}=10 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 6.00 | -6.00 |  | -50 |  |  |
|  |  |  | 2.25 | -2.25 |  | -40 |  |  |
|  |  |  | 4.50 | -4.50 |  | -40 |  |  |
|  |  | $\mathrm{f}_{\text {in }}=1.0 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ | 6.00 | -6.00 |  | -40 |  |  |
| - | Feedthrough Noise. <br> Channel-Select Input to Common I/O (Figure 14) | $\mathrm{V}_{\text {in }} \leq 1 \mathrm{MHz}$ Square Wave ( $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}$ ); | 2.25 | -2.25 |  | 25 |  | mV PPP |
|  |  | Adjust $\mathrm{R}_{\mathrm{L}}$ at Setup so that $\mathrm{I}_{\mathrm{S}}=0 \mathrm{~A}$; | 4.50 | -4.50 |  | 105 |  |  |
|  |  | Enable $=$ GND $\mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 6.00 | -6.00 |  | 135 |  |  |
|  |  |  | 2.25 | -2.25 |  | 35 |  |  |
|  |  |  | 4.50 | -4.50 |  | 145 |  |  |
|  |  | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ | 6.00 | -6.00 |  | 190 |  |  |
| - | Crosstalk Between Any Two <br> Switches (Figure 18) <br> (Test does not apply to HCT4051A) | $\mathrm{f}_{\text {in }}=$ Sine Wave; Adjust $\mathrm{f}_{\text {in }}$ Voltage to | 2.25 | -2.25 |  | -50 |  | dB |
|  |  | Obtain 0 dBm at $\mathrm{V}_{\text {IS }}$ | 4.50 | -4.50 |  | -50 |  |  |
|  |  | $\mathrm{f}_{\text {in }}=10 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=600 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 6.00 | -6.00 |  | -50 |  |  |
|  |  |  | 2.25 | -2.25 |  | -60 |  |  |
|  |  |  | 4.50 | -4.50 |  | -60 |  |  |
|  |  | $\mathrm{f}_{\text {in }}=1.0 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ | 6.00 | -6.00 |  | -60 |  |  |
| THD | Total Harmonic Distortion (Figure 20) | $\mathrm{f}_{\mathrm{in}}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ <br> $T H D=T H D_{\text {measured }}-T H D_{\text {source }}$ <br> $\mathrm{V}_{\text {IS }}=4.0 \mathrm{~V}_{\mathrm{PP}}$ sine wave <br> $\mathrm{V}_{\text {IS }}=8.0 \mathrm{~V}_{\mathrm{PP}}$ sine wave <br> $\mathrm{V}_{\text {IS }}=11.0 \mathrm{~V}_{\mathrm{PP}}$ sine wave |  |  |  |  |  | \% |
|  |  |  | 2.25 | -2.25 |  | 0.10 |  |  |
|  |  |  | 4.50 | -4.50 |  | 0.08 |  |  |
|  |  |  | 6.00 | -6.00 |  | 0.05 |  |  |

*Limits not tested. Determined by design and verified by qualification.


Figure 7a. Typical On Resistance, $\mathrm{V}_{\mathrm{Cc}}-\mathrm{V}_{\mathrm{EE}}=2.0 \mathrm{~V}$


Figure 7b. Typical On Resistance, $\mathrm{V}_{\mathrm{Cc}}-\mathrm{V}_{\mathrm{EE}}=3.0 \mathrm{~V}$


Figure 7c. Typical On Resistance, $\mathrm{V}_{\mathrm{Cc}}-\mathrm{V}_{\mathrm{EE}}=4.5 \mathrm{~V}$


Figure 7e. Typical On Resistance, $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=9.0 \mathrm{~V}$


Figure 7d. Typical On Resistance, $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=6.0 \mathrm{~V}$


Figure 7f. Typical On Resistance, $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=12.0 \mathrm{~V}$


Figure 8. On Resistance Test Set-Up


Figure 9. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up


Figure 11. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up


Figure 13. Off Channel Feedthrough Isolation, Test Set-Up


Figure 10. Maximum Off Channel Leakage Current, Common Channel, Test Set-Up


Figure 12. Maximum On Channel Bandwidth, Test Set-Up


Figure 14. Feedthrough Noise, Channel Select to Common Out, Test Set-Up


Figure 15a. Propagation Delays, Channel Select to Analog Out


Figure 16a. Propagation Delays, Analog In to Analog Out


Figure 17a. Propagation Delays, Enable to Analog Out

*Includes all probe and jig capacitance
Figure 15b. Propagation Delay, Test Set-Up Channel Select to Analog Out

*Includes all probe and jig capacitance
Figure 16b. Propagation Delay, Test Set-Up Analog In to Analog Out


Figure 17b. Propagation Delay, Test Set-Up Enable to Analog Out


Figure 18. Crosstalk Between Any Two Switches, Test Set-Up


Figure 20a. Total Harmonic Distortion, Test Set-Up


Figure 19. Power Dissipation Capacitance, Test Set-Up


Figure 20b. Plot, Harmonic Distortion

## APPLICATIONS INFORMATION

The maximum analog voltage swings are determined by the supply voltages $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$. The positive peak analog voltage should not exceed $\mathrm{V}_{\mathrm{CC}}$. Similarly, the negative peak analog voltage should not go below $\mathrm{V}_{\mathrm{EE}}$. In this example, the difference between $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ is ten volts. Therefore, using the configuration of Figure 21, a maximum analog signal of ten volts peak-to-peak can be controlled. Unused analog inputs/outputs may be left floating (i.e., not connected). However, tying unused analog inputs and outputs to $\mathrm{V}_{\mathrm{CC}}$ or GND through a low value resistor helps minimize crosstalk and feed-through noise that may be picked up by an unused switch.

Although used here, balanced supplies are not a requirement. The only constraints on the power supplies are that:

$$
\begin{gathered}
\mathrm{V}_{\mathrm{CC}}-\mathrm{GND}=2 \text { to } 6 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{EE}}-\mathrm{GND}=0 \text { to }-6 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=2 \text { to } 12 \mathrm{~V} \\
\text { and } \mathrm{V}_{\mathrm{EE}} \leq \mathrm{GND}
\end{gathered}
$$

When voltage transients above $\mathrm{V}_{\mathrm{CC}}$ and/or below $\mathrm{V}_{\mathrm{EE}}$ are anticipated on the analog channels, external Germanium or Schottky diodes ( $\mathrm{D}_{\mathrm{x}}$ ) are recommended as shown in Figure 22. These diodes should be able to absorb the maximum anticipated current surges during clipping.


Figure 21. Application Example


Figure 22. External Germanium or Schottky Clipping Diodes
a. Using Pull-Up Resistors with a HC Device
b. Using HCT Interface


Figure 23. Interfacing LSTTL/NMOS to CMOS Inputs


Figure 24. Function Diagram, HCT4051A


Figure 26. Function Diagram, HCT4052A


Figure 25. Function Diagram, HCT4053A

## MC74HCT4051A, MC74HCT4052A, MC74HCT4053A

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| MC74HCT4051ADG | SOIC-16 <br> (Pb-Free) | 48 Units / Rail |
| MC74HCT4051ADR2G | SOIC-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| MC74HCT4052ADR2G | SOIC-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| M74HCT4052ADTR2G | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| MC74HCT4053ADR2G | SOIC-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| M74HCT4053ADTR2G | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |

DISCONTINUED (Note 1)

| MC74HCT4051ADTG | TSSOP-16 <br> (Pb-Free) | 96 Units / Rail |
| :--- | :---: | :---: |
| M74HCT4051ADTR2G | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| NLV74HCT4051ADTR2G* | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

1. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

SOIC-16 9.90x3.90×1.50 1.27P
CASE 751B
ISSUE L
DATE 29 MAY 2024

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 mm PER SIDE.
5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.


| MILLIMETERS |  |  |  |
| :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX |
| A | 1.35 | 1.55 | 1.75 |
| A1 | 0.00 | 0.05 | 0.10 |
| A2 | 1.35 | 1.50 | 1.65 |
| b | 0.35 | 0.42 | 0.49 |
| c | 0.19 | 0.22 | 0.25 |
| D | 9.90 BSC |  |  |
| E | 6.00 BSC |  |  |
| E1 | 3.90 BSC |  |  |
| e | 1.27 BSC |  |  |
| h | 0.25 | --- | 0.50 |
| L | 0.40 | 0.83 | 1.25 |
| L1 | 1.05 REF |  |  |
| O | 0 | --- | $7 \cdot$ |
| TOLERANCE OF FORM AND POSITION |  |  |  |
| aaa | 0.10 |  |  |
| bbb | 0.20 |  |  |
| ccc | 0.10 |  |  |
| ddd | 0.25 |  |  |
| eee | 0.10 |  |  |



RECOMMENDED MOUNTING FOOTPRINT
*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

| DOCUMENT NUMBER: | 98ASB42566B |  | Document Repositon: rin red. |
| :---: | :---: | :---: | :---: |
| DESCRIPTION: | SOIC-16 9.90X3.90X1.50 1.27P |  | PAGE 1 OF 2 |

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## SOIC-16 9.90x3.90x1.50 1.27P CASE 751B ISSUE L

## GENERIC

MARKING DIAGRAM*

*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-\mathrm{Free}$ indicator, " G " or microdot " $\mathrm{=}$ ", may or may not be present. Some products may not follow the Generic Marking.

| STYLE 1: |  | STYLE 2: |  | STYLE 3: |  | STYLE 4: |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PIN 1. | COLLECTOR | PIN 1. | CATHODE | PIN 1. | COLLECTOR, DYE \#1 | PIN 1. | COLLECTOR, DYE \#1 |
| 2. | BASE | 2. | ANODE | 2. | BASE, \#1 | 2. | COLLECTOR, \#1 |
| 3. | Emitter | 3. | NO CONNECTION | 3. | EMITTER, \#1 | 3. | COLLECTOR, \#2 |
| 4. | NO CONNECTION | 4. | CATHODE | 4. | COLLECTOR, \#1 | 4. | COLLECTOR, \#2 |
| 5. | EMITTER | 5. | CATHODE | 5. | COLLECTOR, \#2 | 5. | COLLECTOR, \#3 |
| 6. | BASE | 6. | NO CONNECTION | 6. | BASE, \#2 | 6. | COLLECTOR, \#3 |
| 7. | COLLECTOR | 7. | ANODE | 7. | EMITTER, \#2 | 7. | COLLECTOR, \#4 |
| 8. | COLLECTOR | 8. | CATHODE | 8. | COLLECTOR, \#2 | 8. | COLLECTOR, \#4 |
| 9. | BASE | 9. | CATHODE | 9. | COLLECTOR, \#3 | 9. | BASE, \#4 |
| 10. | EMITTER | 10. | ANODE | 10. | BASE, \#3 | 10. | EMITTER, \#4 |
| 11. | NO CONNECTION | 11. | NO CONNECTION | 11. | EMITTER, \#3 | 11. | BASE, \#3 |
| 12. | EMITTER | 12. | CATHODE | 12. | COLLECTOR, \#3 | 12. | EMITTER, \#3 |
| 13. | BASE | 13. | CATHODE | 13. | COLLECTOR, \#4 | 13. | BASE, \#2 |
| 14. | COLLECTOR | 14. | NO CONNECTION | 14. | BASE, \#4 | 14. | EMITTER, \#2 |
| 15. | EMITTER | 15. | ANODE | 15. | EMITTER, \#4 | 15. | BASE, \#1 |
| 16. | COLLECTOR | 16. | CATHODE | 16. | COLLECTOR, \#4 | 16. | EMITTER, \#1 |
| STYLE 5: |  | STYLE 6: |  | STYLE 7: |  |  |  |
| PIN 1. | DRAIN, DYE \#1 | PIN 1. | CATHODE | PIN 1. | SOURCE N-CH |  |  |
| 2. | DRAIN, \#1 | 2. | CATHODE | 2. | COMMON DRAIN (OUTPUT) |  |  |
| 3. | DRAIN, \#2 | 3. | CATHODE | 3. | COMMON DRAIN (OUTPUT) |  |  |
| 4. | DRAIN, \#2 | 4. | CATHODE | 4. | GATE P-CH |  |  |
| 5. | DRAIN, \#3 | 5. | CATHODE | 5. | COMMON DRAIN (OUTPUT) |  |  |
| 6. | DRAIN, \#3 | 6. | CATHODE | 6. | COMMON DRAIN (OUTPUT) |  |  |
| 7. | DRAIN, \#4 | 7. | CATHODE | 7. | COMMON DRAIN (OUTPUT) |  |  |
| 8. | DRAIN, \#4 | 8. | CATHODE | 8. | SOURCE P-CH |  |  |
| 9. | GATE, \#4 | 9. | ANODE | 9. | SOURCE P-CH |  |  |
| 10. | SOURCE, \#4 | 10. | ANODE | 10. | COMMON DRAIN (OUTPUT) |  |  |
| 11. | GATE, \#3 | 11. | ANODE | 11. | COMMON DRAIN (OUTPUT) |  |  |
| 12. | SOURCE, \#3 | 12. | ANODE | 12. | COMMON DRAIN (OUTPUT) |  |  |
| 13. | GATE, \#2 | 13. | ANODE | 13. | GATE N-CH |  |  |
| 14. | SOURCE, \#2 | 14. | ANODE | 14. | COMMON DRAIN (OUTPUT) |  |  |
| 15. | GATE, \#1 | 15. | ANODE | 15. | COMMON DRAIN (OUTPUT) |  |  |
| 16. | SOURCE, \#1 | 16. | ANODE | 16. | SOURCE N-CH |  |  |


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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SOIC-16 9.90X3.90X1.501.27P | PAGE 2 OF 2 |

[^1]

TSSOP-16 WB
CASE 948F
ISSUE B
DATE 19 OCT 2006


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 ( 0.006 ) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 ( 0.010 ) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL in EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE - $W$ -

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 4.90 | 5.10 | 0.193 | 0.200 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| c |  | 1.20 |  | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 | SC | 0.026 | BSC |
| H | 0.18 | 0.28 | 0.007 | 0.011 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 | BC | 0.25 | BSC |
| M | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |



| GENERIC <br> MARKING DIAGRAM* |  |
| :---: | :---: |
|  |  |
| XXXX | = Specific Device Code |
| A | = Assembly Location |
| L | = Wafer Lot |
| Y | = Year |
| W | = Work Week |
| G or - | = Pb-Free Package |

*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, " G " or microdot " $\mathrm{\bullet}$ ", may or may not be present. Some products may not follow the Generic Marking.
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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